



Wafer baking technical course



Target group

- Production employees/ manager
- Operators
- Maintenance staff/ manager
- Quality, process manager



Course size and conditions

- Min. 6 / Max. 12 participants
- No experience required.

Early bird offer*:

- 10 %
discount

*valid on training
orders received by
June 30th, 2026



Course content

- Understand key production plant operating processes
- Get familiar with inspection routines, machine operation, and parameter setup/fine-tuning

Deep-dive machine adjustments to improve quality and productivity:

- Baking plate fine settings
- Locking system adjustments
- Burner settings & temperature control
- Troubleshooting

Wafer baking process fundamentals



Date

8–10 Sept. 2026



Location

Wafer Training Center, Leobendorf (Austria)

Costs: 2.990 Euro

Including:

- 3 course days at Bühler Leobendorf
- Detailed training documentation
- Practical demonstration
- Participant certificate
- Lunch and snacks during training stay
- 1 dinner at a typical Austrian restaurant